

Advances in silicon-integrated Micro Solid Oxide Fuel Cells: Towards a new family of ultra-thin portable power sources

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Recent progress on the development of Micro Solid Oxide Fuel Cells (μ SOFC) have positioned this emerging technology as a promising alternative to efficiently power up current energy-demanding portable devices. High instantaneous charge capacity and power density can be reached at relatively low temperatures ($<600^{\circ}\text{C}$) by downscaling classical SOFCs to thin films ($<1\mu\text{m}$ total thickness) and integrating them in silicon micromachined substrates. Now, main challenges for a broad deployment of this technology are on the design of full cells integrable in real handable devices. We analyse here the open issues and we propose different approaches and solutions.

On one side, challenges in materials are mainly related to the still too high operating temperatures, which hinders the encapsulation of μ SOFC modules into final handable devices. To solve that, operating temperatures below 300°C are targetted. We investigate superior oxide-ion conducting materials ($\text{Bi}_2\text{V}_{0.9}\text{Cu}_{0.1}\text{O}_{5.35}$, $\text{La}_{9.33+x}\text{Si}_6\text{O}_{26+1.5x}$) in thin film form as an alternative to the most widely studied electrolyte for μ SOFC, Yttria-stabilized Zirconia. Classical limitations of these materials (poor stability, reactivity) are expected to be overcome by using them as nanometric thin film electrolytes in low-temperature μ SOFC. Area-specific resistances below the target $0.15\ \Omega\text{cm}^2$ for the electrolyte were already measured in $\text{Bi}_2\text{V}_{0.9}\text{Cu}_{0.1}\text{O}_{5.35}$ films at temperatures below 200°C , showing the potential of these materials in this new range of temperatures.

Parallel to that, great efforts are being put on the cell design for (i.) enlarging the active area versus substrate for higher power and (ii.) integrating fuel cell modules with different components of the final portable power device. First, large area μ SOFC membranes have been developed supported in Si-slabs grid, increasing the active area by a factor of $\times 200$. Second, we present fuel cell stacking by Si wafer bonding and the fabrication and integration of micro evaporators, micro reformers and post-combustors, for the operation with easy-to-handle hydrocarbons.

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